

探していた 完璧なテープ

The Perfect Tape
You Are Looking For

打造一台 AI 機器人
需要多少半導體膠帶？



好加企業股份有限公司
Solar Plus Company

【創刊號】

ウェハー BG
Wafer BG

UV ダイシング
UV Dicing

熱剝離
Thermal Release

アドバンスドパッケージング
Advanced Packaging



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About Us

What we support for ESG & Sustainability



Founded in 1980, Solar Plus Company manufactures high performance tapes majorly for semiconductor and green energy industry.

We provide wafer UV dicing tape, thermal release tape, wafer BG tape, QFN packing tape, PCB, MLCC and LED masking tape, anti-static tape...etc.

High quality products with **【eco-friendly process】** and **【recycle material】**; it is our responsibility to achieve the goal of ESG & sustainability.

好加企業股份有限公司擁有40年歷史
為半導體膠帶製造商，致力於ESG永續發展，並提供專業諮詢與客製化的服務。

產品應用於半導體產業

前端製程: 晶圓研磨膠帶、晶圓切割膠帶

後端製程: 各種材質基板切割、LED灌封膠帶、PCB & FPCB 遮蔽膠帶、
MLCC、IC封裝、光電、被動電子零組件...等產業應用。

產品應用於其他產業

風力發電、太陽能電池、航太、運輸、醫療、傳統工業等製程或產品
密封、貼合、固定、承載、沖型、遮蔽、保護、轉移

Solar Plus のフィロソフィ と 京セラは一緒

純粋な心で人生を歩んで、

全従業員の物心両面の幸福を追求すると
同時に、人類、社会の進歩発展に貢献すること。

我們的優勢

Our advantages

台灣製造

Made in Taiwan guarantee

品質穩定

Stable quality performance

客製化研發與服務

Flexible custom made service

專業諮詢

Professional consulting

改善產品製程

Improving production process



晶圓研磨膠帶 Wafer Back Grinding Tape

- 高平整度、延展性佳、耐溫、耐酸鹼，用於晶圓研磨與保護。
- 晶圓切割、清潔、基板切割。
- High flatness, great elongation, acid, alkali and heat resistance for wafer back grinding, thinning protection, or substrate cutting.
- Lift-off cleaning.

POL Series

Model	Material	Thickness	Adhesion	Feature
POY143	PO+Liner	170 μm	0.15 $\pm$ 0.1 kg/in.	High flatness
POR146	PO+Liner	170 μm	0.35 $\pm$ 0.1 kg/in.	High flatness
POL803	PO+Liner	95 μm	0.2 $\pm$ 0.1 kg/in.	No residue
POL804-2	PO+Liner	87 μm	0.06-0.12 kg/in.	Low adhesion
POL835	PO+Liner	93 μm	0.3-0.5 kg/in.	Medium adhesion
POU200	PO+Liner	200 μm	0.3 $\pm$ 0.2 kg/in.	For bumped wafer



UV 低能量解黏膠帶 UV Low Energy Release Tape

- 使用特定波長紫外線照射後，能大幅減低黏著力至極低黏，其為不可逆反應，使黏貼物易於脫離膠膜。
- 產品應用廣，晶圓研磨製程、晶片切割製程、LED 切割、MLCC製程、光學鏡片製程、陶瓷片或任何材質基板、導線架切割。
- 低能量解黏，加速製程，亦可指定抗靜電版本。
- Used with UV light exposure (with certain wavelength), the adhesion is greatly reduced (irreversible reaction), the object is then easily removed and picked up after operation.
- Used in wafer grinding, chip dicing, MLCC cutting, LED dicing, lens cutting, substrate cutting or lead frame cutting.
- Anti-static version is available.
- Low energy release, speed up the production process.

LE Series

Model	Material	Thickness	Before UV Curing Adhesion	After UV Curing Adhesion	Feature
UPT143LE	PO+Liner	170 μm	2.5 kg/in.	0.03 kg/in.	Dicing, grinding, great expansion
UPT152LE	PO+Liner	172 μm	1.8 $\uparrow$ kg/in.	0.03 kg/in.	Dicing, grinding, great expansion
UPT805LE	PO+Liner	86 μm	0.5~0.9 kg/in.	0.015 $\downarrow$ kg/in.	Dicing, grinding, great expansion
UPT104LE	PO+Liner	125 μm	1.3 $\uparrow$ kg/in.	0.02 $\downarrow$ kg/in.	Dicing, grinding, great expansion

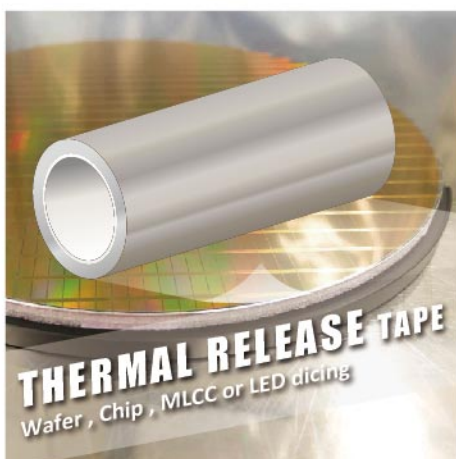


UV 解黏膠帶、切割膠帶 UV Release Tape, Dicing Tape

- 產品多應用於晶圓研磨製程、晶片切割製程、MLCC 切割製程、LED 切割、各種基板切割、銘版切割或半導體電子產業切割與轉貼。
- 長時間耐熱性佳。
- Good for heat resistant purposes.
- Used in wafer back grinding, chip dicing, MLCC cutting, LED dicing, lens dicing, nameplate cutting and any substrate cutting.

UET / UPT Series

Model	Material	Thickness	Before UV Curing Adhesion	After UV Curing Adhesion	Feature
UET101	PET+Liner	125 μ m	2 $\uparrow$ kg/in.	0.03 $\downarrow$ kg/in.	Semiconductor front or back end dicing
UET113P	PET+Liner	110 μ m	0.9 $\uparrow$ kg/in.	0.03 $\downarrow$ kg/in.	
UET123P	PET+Liner	125 μ m	2 $\uparrow$ kg/in.	0.03 $\downarrow$ kg/in.	
UPT155	PO+Liner	170 μ m	1.2 $\uparrow$ kg/in.	0.05 $\downarrow$ kg/in.	
UPT152-11	PO+Liner	170 μ m	1.2 $\uparrow$ kg/in.	0.05 $\downarrow$ kg/in.	

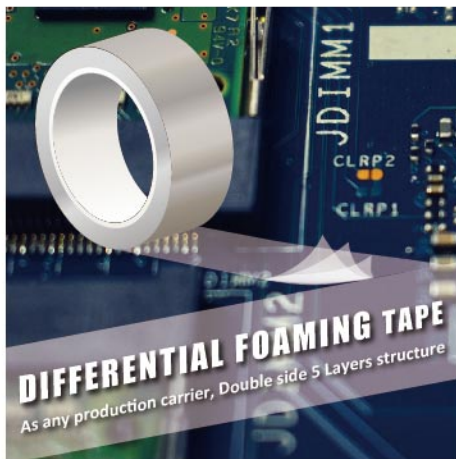


熱解黏膠帶 Thermal Release Tape

- 主要應用在製程切割、保護、承載用。
- 在常溫下有黏著力，可以有效在切割時固定產品，使其不位移、不飛片，加熱後即可輕易剝落。
- 晶圓研磨製程、晶片、陶瓷片、MLCC、LED、鏡頭鏡片、基板、銘版或其他半導體產業之晶圓晶粒切割。
- Provides great holding adhesion during dicing operation at regular temperature, objects are not moved or flying.
- Easily released after heating for 3-5 min.
- For wafer dicing, substrate dicing, MLCC dicing, LED or passive components production process.

FCL Series

Model	Material	Thickness	Before Heating Adhesion	After Heating Adhesion	Release Temperature
FCL90980-1	PO+Liner	125 μ m	1.2 $\uparrow$ kg/in.	0.015 $\downarrow$ kg/in.	100°C, 3-5 min
FCL70810-1	PET+Liner	150 μ m	0.6 $\uparrow$ kg/in.	0.015 $\downarrow$ kg/in.	85°C, 3-5 min
FCL70950	PET+Liner	95 μ m	0.4-0.7 kg/in.	0.015 $\downarrow$ kg/in.	90°C, 3-5 min
FCL125-6	PET+Liner	130 μ m	1.0 $\uparrow$ kg/in.	0.015 $\downarrow$ kg/in.	120°C, 3-5 min
FCL71538-6	PET+Liner	91 μ m	0.4 $\uparrow$ kg/in.	0.015 $\downarrow$ kg/in.	150°C, 3-5 min
FCL72010	PET+Liner	150 μ m	0.3 $\uparrow$ kg/in.	0.015 $\downarrow$ kg/in.	200°C, 3-5 min
FCL72625	PI+Liner	80 μ m	0.6 $\uparrow$ kg/in.	0.015 $\downarrow$ kg/in.	260°C, 3-5 min

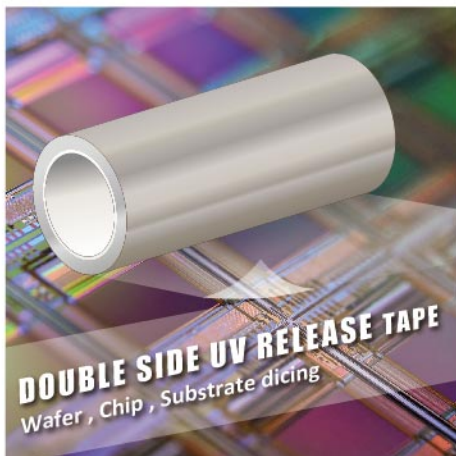


雙面熱解膠帶 Double Side Thermal Release Tape

- 雙面發泡熱解膠，適合任何製程。
- 一面低黏、一面發泡熱解膠設計，適合各式基板切割、轉貼、承載、暫時固定用。
- 防呆離型膜設計，使用便利。
- One or double side with foaming adhesive, for any production process, as carrier or temporary fixing.
- Differential adhesion, for substrate or lead frame cutting.

SDF Series

Model	Material	Thickness	Before Heating Adhesion	After Heating Adhesion	PSA Side Adhesion	Release Temperature
SDF30850-1R	PET	130 μm	0.1-0.4 kg/in.	0.015 $\downarrow$ kg/in.	-	85°C, 3-5 min
SDF90910	PET	186 μm	0.8 $\uparrow$ kg/in.	0.015 $\downarrow$ kg/in.	-	90°C, 3-5 min
SDF90910	PET	160 μm	0.9 $\uparrow$ kg/in.	0.015 $\downarrow$ kg/in.	0.2 $\uparrow$ kg/in.	100°C, 3-5 min
SDF91210-2	PET	180 μm	1.0 $\uparrow$ kg/in.	0.015 $\downarrow$ kg/in.	-	120°C, 3-5 min
SDF91510-2	PET	190 μm	0.9 $\uparrow$ kg/in.	0.015 $\downarrow$ kg/in.	-	150°C, 3-5 min
SDF71938-2	PET	144 μm	0.5 $\uparrow$ kg/in.	0.015 $\downarrow$ kg/in.	-	190°C, 3-5 min
SDF72038	PET	96 μm	0.3 $\uparrow$ kg/in.	0.015 $\downarrow$ kg/in.	0.3 $\uparrow$ kg/in.	210°C, 3-5 min
SDF72425	PI	135 μm	0.5 $\uparrow$ kg/in.	0.015 $\downarrow$ kg/in.	-	260°C, 3-5 min



雙面UV或UV熱解黏膠帶 Double Side UV or UV/Thermal release tape

- 雙面UV解黏，或一面UV解黏、另一面熱解黏設計，適用任何製程改善、固定、承載等用途，防呆離型膜設計，方便施做。
- 低能量解黏，加速製程，亦可指定抗靜電版本。
- Double sided UV release design, or one side UV release, the other side with thermal release function.
- For any production process.
- Different release liner peeling force, easy for distinguish A & B sides.
- Low energy release, speed up the production process.
- Anti-static version is available.

UDD Series

Model	Material	Thickness	Before UV Curing A Side Adhesion	After UV Curing A Side Adhesion	Before UV Curing B Side Adhesion	After UV Curing B Side Adhesion
UDD105P	PET	120 μm	0.3 $\pm$ 0.2kg/in.	0.02 $\downarrow$ kg/in.	0.3 $\pm$ 0.2kg/in.	0.02 $\downarrow$ kg/in.

UTD Series (UV Curable / Thermal Release Double Side Tape)

Model	Material	Thickness	Before UV Curing A Side Adhesion	After UV Curing A Side Adhesion	Before Heating B Side Adhesion	After Heating 90°C-3min B Side Adhesion
UTD502-2	PET	115 $\pm$ 6 μm	0.7 $\pm$ 0.3 kg/in.	0.03 $\downarrow$ kg/in.	0.5 $\pm$ 0.3 kg/in.	0.01 $\downarrow$ kg/in.



QFN 膠帶 QFN Tape

- 適用於 QFN 封裝時，避免 EPOXY 溢出。
- 由 PI 膜 (POLYIMIDE) 上塗佈特殊矽膠，高溫時穩定性佳，不殘膠。
- Used in QFN molding process, to avoid EPOXY bleeding.
- Polyimide film coated with special formulated silicone adhesive.
- Consistently stable at high temperature, no residue after peeling off.

QFN Series

Model	Material	Thickness	Adhesion	Temp. Resistant	Feature
KAL278	PI+Liner	33 μm	0.05-0.15 kg/in.	260°C	High temperture resistant
KAL279	PI+Liner	35 μm	0.1-0.25 kg/in.	260°C	High temperture resistant



PI (Kapton) 膠帶 PI Tape

- 適用於 PCB 板含浸過程中遮蔽金手指部份，防止電鍍液浸入及汙染。
- 具有絕緣及高散熱特性的產品適用、包覆鋰電池。
- 應用在電熱器的電路、電源供應器上及軟性印刷電路板的電路上。
- 耐高溫、絕緣佳，用於電容、防焊、馬達、線頭、錫爐等使用。
- 可貼合離型膜方便斬型使用。
- Used in masking operation during wave solder process on PCB, prevent electroplating liquid immersion and polluting.
- Insulation and high heat dissipation for lithium battery wrapping.
- Wiring in heater, power supply and flexible printed circuit board.

KA Series

Model	Material	Thickness	Adhesive	Adhesion	Temp. Resistant	Anti-static
KA105	PI	57 μm	Silicone	0.5 $\uparrow$ kg/in.	290°C	-
KA105#125	PI	161 μm	Silicone	0.5 $\uparrow$ kg/in.	290°C	-
KA104	PI	61 μm	Silicone	0.65 $\uparrow$ kg/in.	260°C	-
KA105RP	PI+Liner	61 μm	Silicone	0.5 $\uparrow$ kg/in.	290°C	-
KA214	PI	35 μm	Silicone	0.1-0.15 kg/in.	260°C	-
KA102	PI	56 μm	Acrylic	0.7 $\uparrow$ kg/in.	180°C	-
KAL605	PI+Liner	61 μm	Silicone	0.5 $\uparrow$ kg/in.	290°C	PSA: $10^8 \sim 10^{11} \Omega/\text{sq.}$
KA605AS	PI	61 μm	Silicone	0.5 $\uparrow$ kg/in.	290°C	PSA: $10^8 \sim 10^{11} \Omega/\text{sq.}$ Film: $10^3 \sim 10^8 \Omega/\text{sq.}$



耐高溫雙面夾心膠帶 High Temperature Resistance Sandwich Tape

- 耐高溫，可客製化設計成不同黏著力或膠厚，五層結構。(請參考 P.11)
- 高低斷差面產品之加工保護。
- High temperature resistant, for reflow process, re-usable.
- 5 layers structure. (See page 11.)
- Bumping surface protection.

SDK Series

Model	Material	Thickness	Back side Adhesion	Face side Adhesion	Temp. Resistant
SDK578	PI+Liner	200 μm	0.9 $\uparrow$ kg/in. (Silicone)	0.9 $\uparrow$ kg/in. (Silicone)	220°C
SDK586	PI+Liner	225 μm	0.95 $\uparrow$ kg/in. (Silicone)	0.35-0.55 kg/in. (Silicone)	220°C

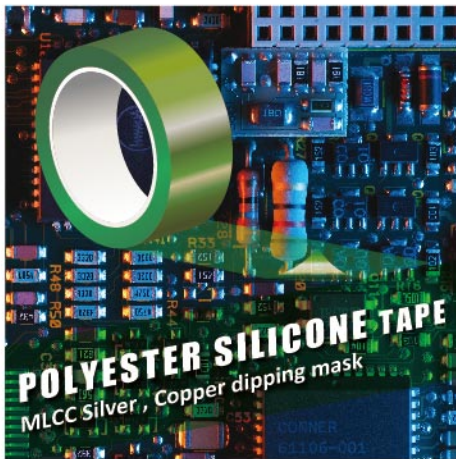


耐高溫雙面膠帶 High Temperature Resistance Double Side Tape

- 耐高溫，可用於迴焊，重複黏貼，客製化間隔膠，確保製程流暢，機台不殘膠。(間隔膠請參考 P12.)
- 耐高溫烘箱除塵應用，雙面不同黏著力與膠厚設計。
- High temperature resistant, for reflow process, re-usable.
- Oven cleaning tape. Optional two sides with different adhesion and thickness, multi-functional.
- Strip tape is available for custom coating & size. (See P12.)

DST / DSK Series

Model	Material	Thickness	Adhesive	Back side Adhesion	Face side Adhesion	Temp. Resistant
DSK565	PI+Liner	164 μm	Silicone	0.05-0.1 kg/in.	0.8 $\uparrow$ kg/in.	220°C
DSK545	PI+Liner	145 μm	Silicone	0.6 $\uparrow$ kg/in.	0.7 $\uparrow$ kg/in.	220°C

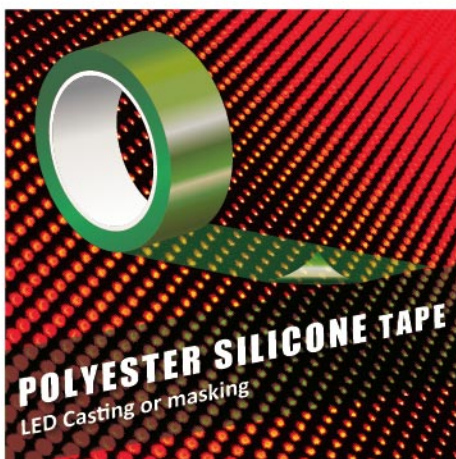


矽膠膠帶 Silicone Tape

- 耐高溫、高阻隔性、無殘膠。應用於 JIG 板、MLCC 沾銅、沾銀製程 PCB、鍍金隔絕保護、矽膠離型接頭膠帶、粉體烤漆遮蔽...等製程。
- 客製防呆顏色、客製化間隔膠，間隔上膠保證不溢膠，確保製程流暢。
- High temperature resistant, great insulation and no residue.
- Applied on JIG board, for MLCC silver or copper dipping process, PCB gold plating masking, silicone release paper splicing, or any coating masking.
- Custom colors are available.
- Custom strip tape, no oozing guarantee. (See P12.)

GT Series

Model	Material	Thickness	Adhesion	Temp. Resistant	Applications
GTG225R	PET	50 μm	0.6-0.8 kg/in.	200°C	MLCC 0603 Dipping
GTBL225R	PET	50 μm	0.4 $\uparrow$ kg/in.	200°C	MLCC 0603 Dipping
GTG228	PET	54 μm	0.3 $\uparrow$ kg/in.	200°C	MLCC 0402 Dipping
GTG254	PET	75 μm	0.7 $\uparrow$ kg/in.	200°C	Splicing
GTY575	PET	123 μm	0.9 $\uparrow$ kg/in.	200°C	Splicing
GTU535H	PET	61 μm	0.5 $\uparrow$ kg/in.	200°C	Strip Tape, no oozing
GLT520	PET+Liner	69 μm	0.7 $\uparrow$ kg/in.	200°C	Die or kiss cutting

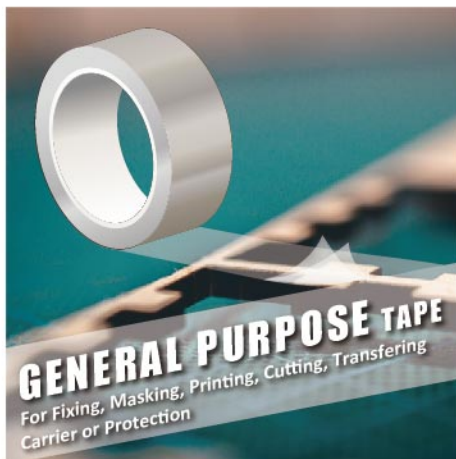


LED 膠帶 LED Casting Tape

- LED EPOXY 灌封專用膠帶
- 另有 UV 或熱解膠帶可供切割製程使用 (請參考 P4)
- 高溫保護用，不殘膠。
- 經過貼合加工 LED 表面產生亮面及霧面的效果。
 - 亮面 - GT
 - 霧面 - GTTM
- LED EPOXY casting.
- UV or thermal release tapes are for dicing process (Page 4.).
- Masking in high temperature, no residue.
- Apply for LED surface as gloss or matt finished.

LED Series

Model	Material	Thickness	Adhesion	Temp. Resistant	Applications
GTTM331	PET	74 μm	0.5 $\uparrow$ kg/in.	150°C	LED EPOXY casting
GTG275R	PET	102 μm	0.7 $\uparrow$ kg/in.	200°C	LED EPOXY casting
GTTM351	PET	88 μm	0.7 $\uparrow$ kg/in.	150°C	LED EPOXY casting



通用型膠帶 General Tape

- 晶圓盒、晶圓卡匣、Tray 盤密封用。
- 晶圓研磨後之撕膜膠帶、移除大面積膠膜。
- 銘版製程保護、銘版切割、固定、密封、斬型、轉貼、遮蔽、承載、3C 商品保護等，用途廣泛，適用各種產業與無矽污染製需求。
- Wafer cassette case sealing tape.
- De-taping tape.
- Nameplate cutting protection, fixing, sealing, die / kiss cutting, transferring, masking, carrier, 3C product protection or silicone free process.

LPT / ET / ELT Series

Model	Material	Thickness	Adhesion	Feature
LPT236	PET	45 μm	0.4-0.6 kg/in.	Very low out gasing
LPT50	PET	62 μm	0.03-0.07 kg/in.	For protection
ELT555	PET+Liner	62 μm	0.015-0.025 kg/in.	With liner for die or kiss cut protection
ELT704	PET+Liner	85 μm	0.01 $\downarrow$ kg/in.	With liner for die or kiss cut protection
ETU262	PET+PET	142 μm	0.6 $\uparrow$ kg/in.	Two layers masking
ETT293	PET	55 μm	1.2 $\uparrow$ kg/in.	De-taping tape
ETT548R	PET	100 μm	2.0 $\uparrow$ kg/in.	De-taping tape
ETT588R-5	PET	85 μm	1.5 $\uparrow$ kg/in.	De-taping tape
ELT228	PET+Liner	35 μm	0.15 kg/in.	200°C resistant, silicone free process



抗靜電膠帶 Anti-Static Tape

- 防止靜電特殊膠帶，主動 / 被動電子元件包裝膠帶。
- 無塵室使用，避免吸附灰塵顆粒。
- 黏貼 Tray 盤，無塵室、電子產品包裝用。
- 撕膜膠帶。
- Anti-static action, tray cover tape.
- Used in clean room, to avoid dust particles.
- Applied on active or passive components packaging.
- De-taping tape.

SAT Series

Model	Material	Thickness	Adhesive	Adhesion	Anti-static
SAT231	PET	52 μm	Acrylic	0.7-1.0 kg/in.	PSA: $10^8 \sim 10^{11} \Omega/\text{sq.}$
SAT270	PET	52 μm	Acrylic	1.2 $\uparrow$ kg/in.	PSA: $10^3 \sim 10^6 \Omega/\text{sq.}$
GTT601RAS	PET	90 μm	Silicone	0.7 kg/in.	PSA: $10^8 \sim 10^{11} \Omega/\text{sq.}$ Film: $10^6 \sim 10^9 \Omega/\text{sq.}$

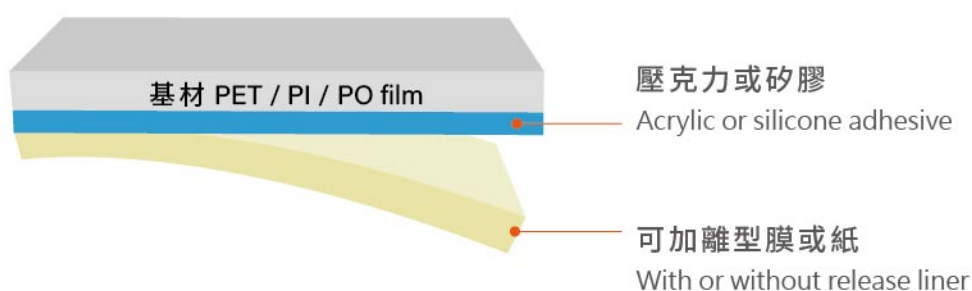
客製化膠帶 Custom Made Tape

膠帶結構 Tape Structure

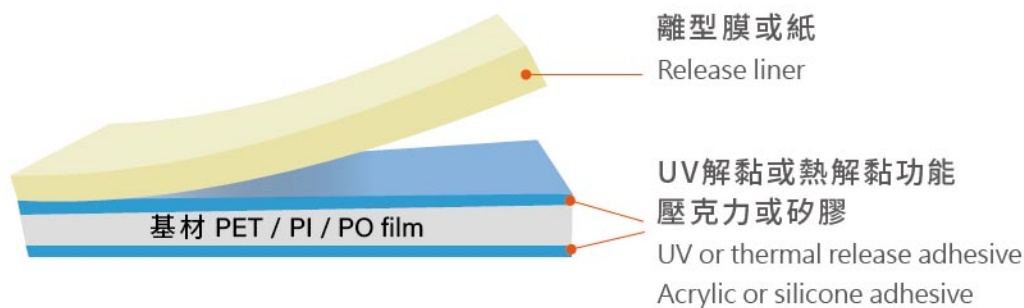
好加企業在膠帶上的設計，擁有很大的自由度，膠帶的塗佈可以是一面普通感壓膠，另一面塗佈熱解黏或UV解黏膠，或者一面高黏度，一面低黏度等。獨特的設計可以迎合不同製程的需求，增進製程效率，提升產品良率。

Our tape can be designed with different coating such as, adhesion difference. It is possible to make one side coated with PSA adhesive, and the other side coated with thermal release or UV release adhesive. With these groundbreaking ideas you can make the production yield going up.

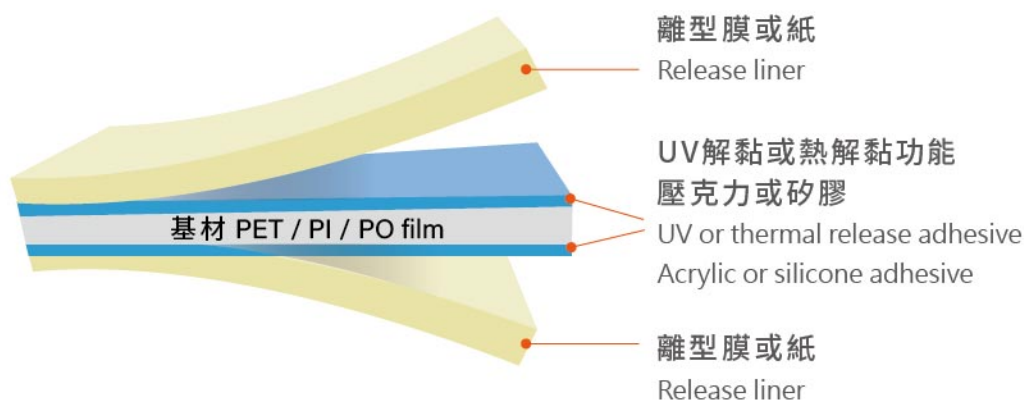
一般膠帶 Regular Tape



雙面高低黏膠帶 Double Sided Differential Tape

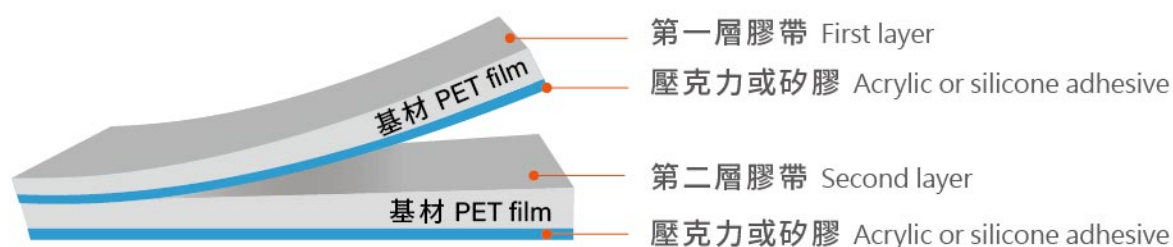


五層結構夾心雙面膠帶 Sandwich Tape

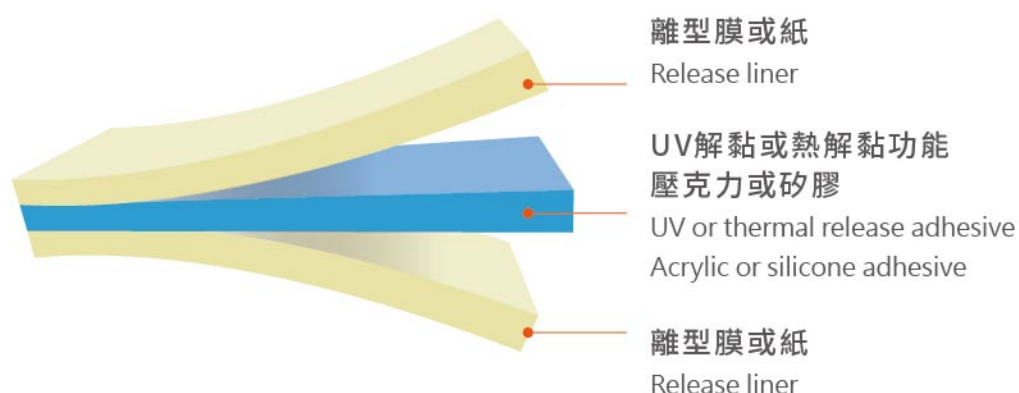


客製化膠帶 Custom Made Tape

雙層遮蔽膠帶 Two Layers Masking Tape



無基材膠帶 Transfer Tape



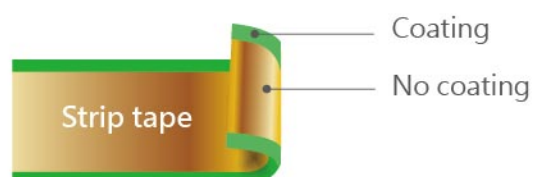
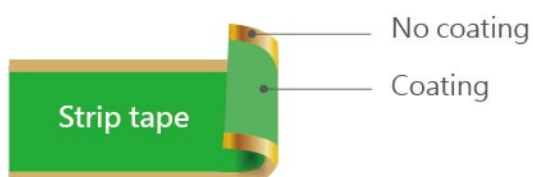
間隔膠 Strip Tape

間隔膠帶的製作，顧名思義就是只塗佈在局部範圍，做成有間隙的成品，無論是中間塗膠或兩側塗膠，亦或是間隙的尺寸，均可客製化。

除了間隔膠的塗佈客製尺寸，顏色選擇亦可以做防呆客製化。

Strip tape is only coated on certain areas of the film to create spacing. No matter it is coated in the center, two sides of the tape or the gaping size, these conditions are able to be custom made.

The coating color is also can be custom made for error proof distinguish.





自行車無內胎輪襯帶 Bicycle Tubeless Rim Tape

- 耐高溫、適合公路車輪框需耐高溫煞車特性。
- 各種車種皆適合，高胎壓碳纖輪組只需纏繞一圈即可快速施工，加快組輪廠產能。
- 特殊膠水配方，不留殘膠，輪框清潔、保養容易，讓終端消費者滿意。
- 寬度、長度、Logo、顏色皆可客製。
- Heat & high pressure resistant.
- Great sealing adhesion without residue, easy for installation and maintenance.
- Custom logo, color, length or width are available.

Rim Tape Series

Model	Material	Temperature resistant	Feature
KAB743	PI (Black)	260°C	Universal wheelset
KA735	PI	260°C	Universal wheelset
KA104#50	PI	260°C	Universal wheelset
GTB540	PET	-10 ~ 200°C	Universal wheelset
ETB561	PET	-10 ~ 120°C	Disc Brake wheelset
OTU852	MOPP	-10 ~ 80°C	Disc Brake wheelset
PTM130	PO	-10 ~ 80°C	Disc Brake wheelset



麥拉耐燃膠帶 Mylar Insulation Tape

- PET 壓克力膠帶。
- 適用於各種電子零件絕緣用。
- 有耐燃效果適用於線圈的包裝或是小型變壓器需絕緣部份。
- 間隔上膠，多種顏色選擇，可客製化 Logo 與圖案。
- PET acrylic Mylar tape, for any electronic device insulation.
- Flame retardant, for cable coiling or small transformer components insulation.
- Strip coating, custom color, logo or artwork are available.

Mylar / ET Series

Model	Material	Thickness	Adhesion	Feature
ETB	PET	54 μ m	1.0 $\uparrow$ kg/in.	Marking or cable coiling
ETT50	PET	79 μ m	1.0 $\uparrow$ kg/in.	Marking or cable coiling
ETB962	PET	57 μ m	0.7 $\uparrow$ kg/in.	Flame retardant
ETW963	PET	57 μ m	0.7 $\uparrow$ kg/in.	Flame retardant
ETY1561H	PET	30 μ m	0.2 $\uparrow$ kg/in.	Strip coating
ELT530H	PET+Liner	79 μ m	1.2-1.8 kg/in.	Strip coating



包裝膜、轉貼膠帶 Transfer Tape / Film

- 黏度可依不同需求選擇使用，不殘膠，可作保護使用。
- 可應用於 PVC 商標等電腦刻字或圖形的定位、轉貼。電子零件之承載膜及表面保護、無塵室暫時黏貼、捆繞固定.....等用途。
- 保護加工材料及避免碰撞損壞方面，如：金屬、烤漆等。
- 防疫保護膜的應用，保護電梯、電話、ATM、任何機台按鈕、觸控面板，防止酒精或消毒水滲入造成儀器損壞。
- Transfer vinyl graphics, decals or computer lettering advertising signs.
- Custom made is available.
- Precaution film for any button or touch panel's protection.

PTT Series

Model	Material	Thickness	Adhesion	Feature
PTTR4620	OPP	49 μm	0.02-0.04 kg/in.	Low Tack
PTT610	OPP	70 μm	0.015 $\downarrow$ kg/in.	Low Tack
PTT400E	OPP	52 μm	0.1-0.4 kg/in.	Medium Tack
PTT700	OPP	52 μm	0.4-0.7 kg/in.	High Tack



特殊雙面、夾心膠帶 Special Double Side / Sandwich Tape

- 四或五層結構，中間材質棉紙或PET。
- 適用於銘版、各種產品接著的使用。
- 一面矽膠、一面壓克力膠，或雙面高、低黏著力等設計。
- 4 or 5 layers structure, backing material: paper or PET.
- Splicing for any material.
- Transfer tape.

DS / SD Series

Model	Material	Thickness	Adhesion	Feature
DSTE414	PET+glassine liner	94 μm	1.8 $\uparrow$ kg/in.	Splicing
DSTE213W	PET+white release paper	49 μm	A side 1.0~1.6 kg/in. B side 0.4~0.6 kg/in.	Temporary fixing, dust remover
DSE245-2	PET+white release paper	115 μm	3.0 $\uparrow$ kg/in.	High adhesion application
SDA274	PET+PET liner	166 μm	Silicone side 1.2 $\uparrow$ kg/in. Acrylic side 2.0 $\uparrow$ kg/in.	Two side with different adhesive
SDE328-2	Transparent tape	96 μm	0.4 $\uparrow$ kg/in.	Photo protection & fixing



鋁箔貼 Aluminum Foil Tape

- 排油煙管保護、牆面保護、耐燃素鋁箔貼。
- 貨櫃內部修繕。
- Container fixing (sea freight container)
- Exhaust pipe fixing or wall flame retardant protection.

FOL Series

Model	Material	Thickness	Adhesion	Applications
SFOL50Z48	Alu. foil	79 μm	1.2 $\uparrow$ kg/in.	Fixing or protection, flame retardant
FOL984	Alu. foil	98 μm	1.2 $\uparrow$ kg/in.	Fixing or protection, flame retardant
FOL589	Alu. foil	85 μm	1.2 $\uparrow$ kg/in.	Fixing or protection, flame retardant



除塵貼 Cleaning Tape

- 無塵室專用除塵貼。
- 清潔除塵腳踏墊。
- 各種機台、設備、電子面板除塵。
- 製程除塵、產品除塵。
- For clean room dust remover.
- Dust remover mat.
- Laboratory dust cleaner.
- All kind of device / panel cleaning.
- Production process cleaning.

YTP Series

Model	Material	Thickness	Adhesion	Applications
YTP710	Synthetic Film	77 μm	0.05-0.2 kg/in.	Clean room clean panel, dust remover
YTP735	Synthetic Film	90 μm	0.3-0.4 kg/in.	
YTP745	Synthetic Film	90 μm	0.4-0.5 kg/in.	
YTP755	Synthetic Film	90 μm	0.5-0.6 kg/in.	
WCT374	PET	68 μm	0.8 $\downarrow$ kg/in.	



Website



Line@



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